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Customer Number

Patent  
Case No.: 55044US009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: **GOETZ, DOUGLAS P.**

Application No.: **10/662,084**

Confirmation No.: **8857**

Filed: **September 12, 2003**

Title: **FIXED ABRASIVE ARTICLE FOR USE IN MODIFYING A  
SEMICONDUCTOR WAFER**

**RESPONSE TO RESTRICTION REQUIREMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF MAILING OR TRANSMISSION [37 CFR § 1.8(a)]**

I hereby certify that this correspondence is being:

- ☐ deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
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Date

Signed by:

Dear Sir:

This is in response to the Office Action mailed November 17, 2006. Claims 1 and 4-17 are pending. Claims 1 and 4-17 were restricted under 35 USC § 121 as follows:

I. Claims 1 and 4-14 are said to be drawn to an apparatus for modifying the surface of a semiconductor wafer, classified in Class 451, subclass 296;

II. Claims 15-17 are said to be drawn to a method of modifying the surface of a semiconductor wafer, classified in Class 451, subclass 41;

Reconsideration and withdrawal or modification of the restriction requirement is respectfully requested in view of the following arguments.